

		1					
LOC	DIST	REVISIONS					
H	—	P	LTR	DESCRIPTION	DATE	DWN	APVD
			L	REVISED PER ECO-13-014710	07NOV2013	SY	FY

NOTES:

- 1

MATERIAL CONTACTS; PHOSPHORBRONZE
- 2

MATERIAL HOUSING; GLASSFILLED POLYESTER (GRAY)
- 3

GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1,27µm NICKEL MIN. AND ACTION PIN: 0,5µm TIN-LEAD MIN. FOR PLATING OF MATING SURFACES SEE APPLICABLE SPECIFICATION REFERENCE FOR EACH DASH NUMBER.
- 4

CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 2.
- 5

CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 1.
- 6

CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL III, CENTRAL OFFICE APPLICATIONS.
- 8

CONNECTOR LUBRICATED WITH TELCORDIA APPROVED LUBRICANT.
- 9

ASSEMBLY PRINTED WITH P/N AND DATECODE
- 10

THE MARKING CAN APPEAR ON THE FRONT SIDE OR BACK SIDE.
- 11

HOLE PATTERN FOR FEMALE CONNECTOR TYPE B-22 COLUMNS 110 PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID
- 12

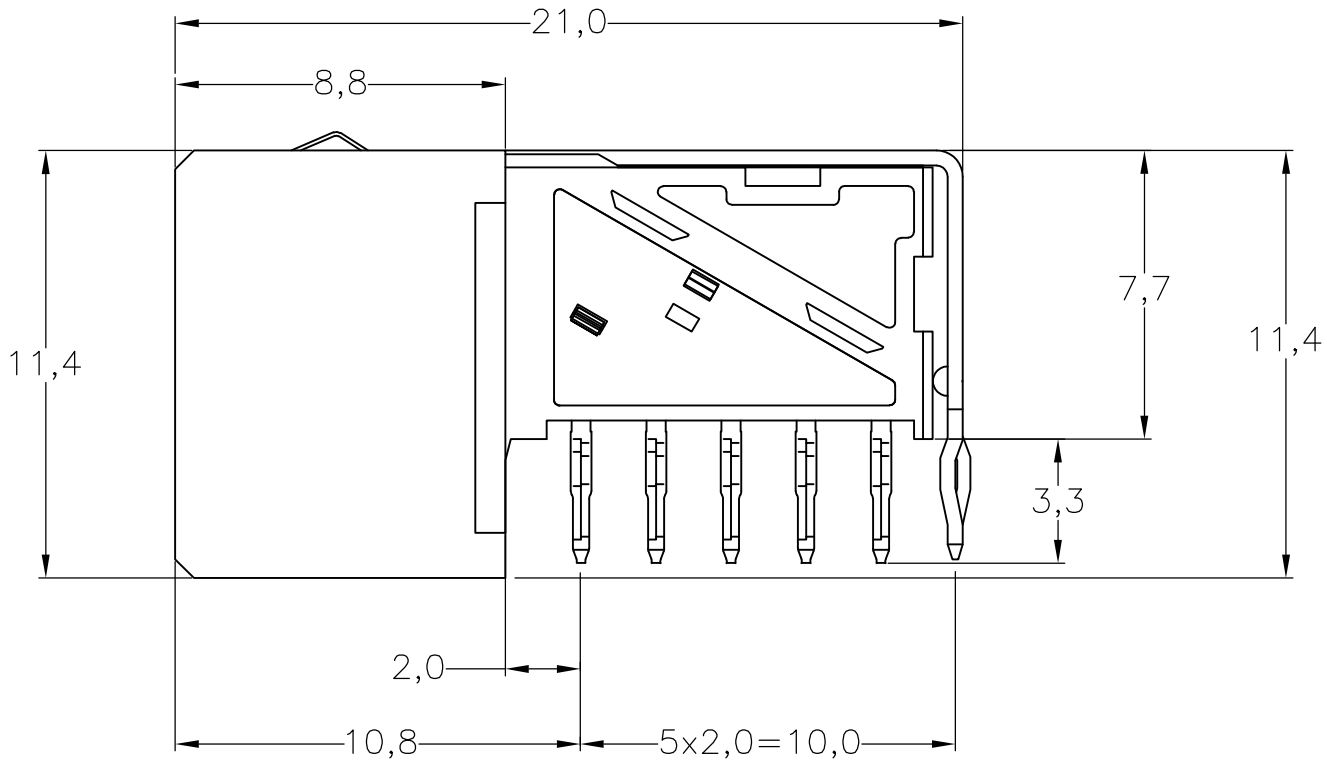
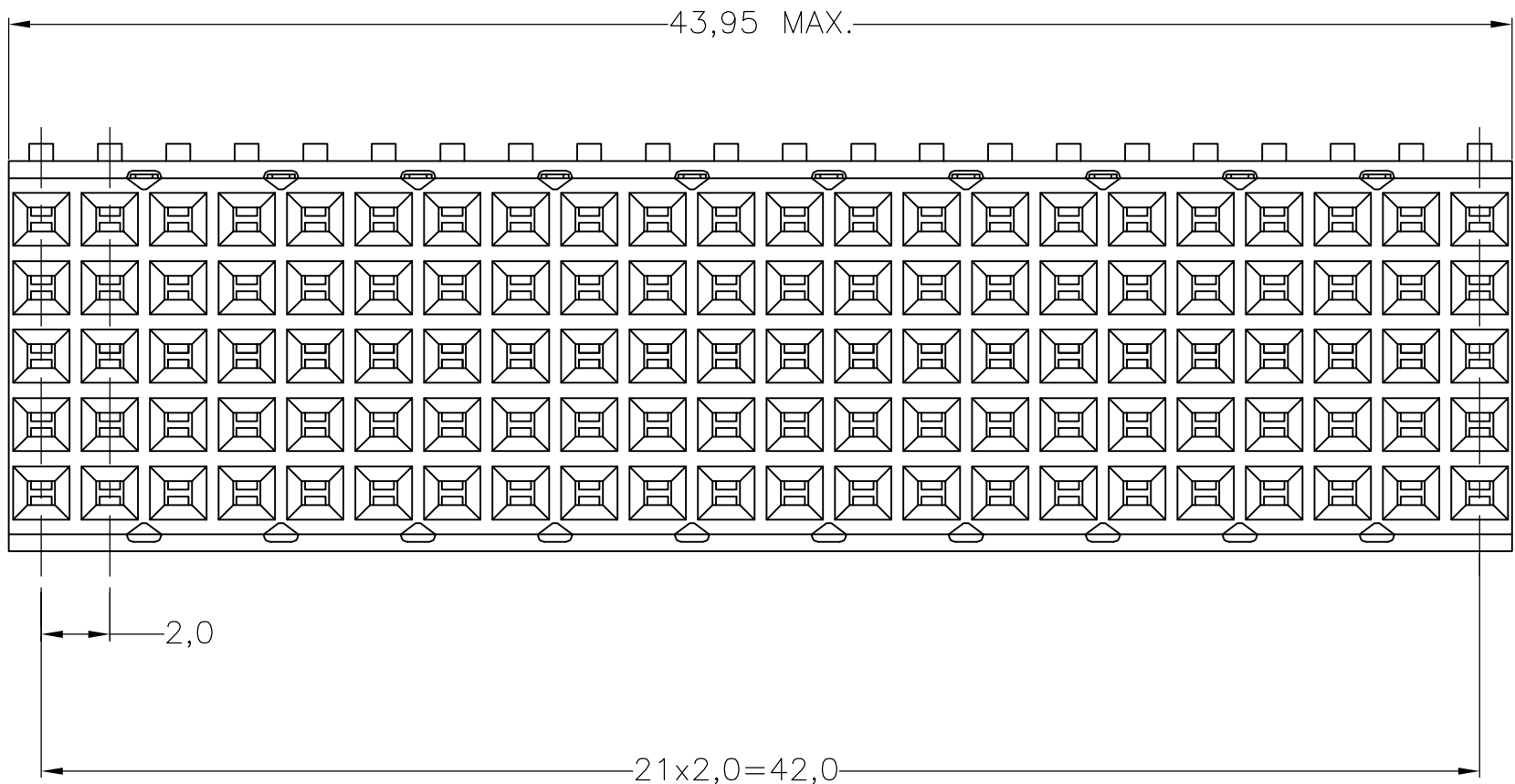
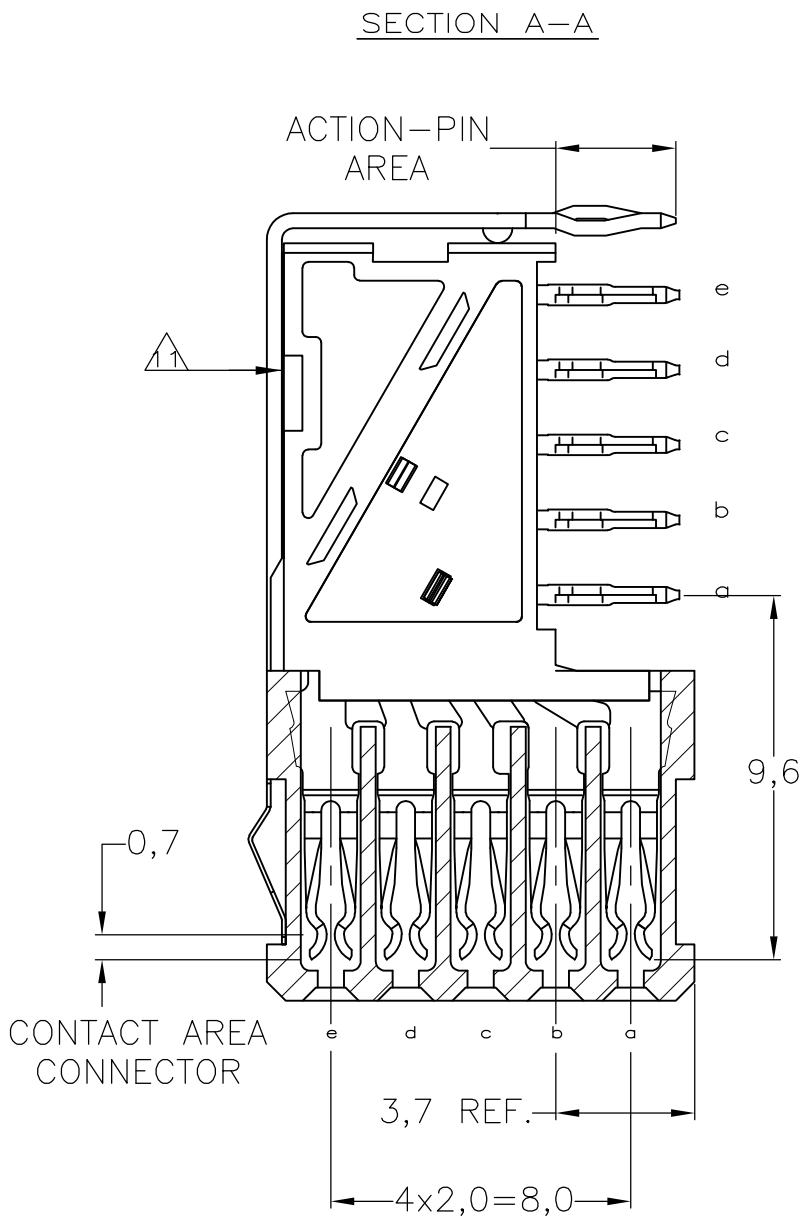
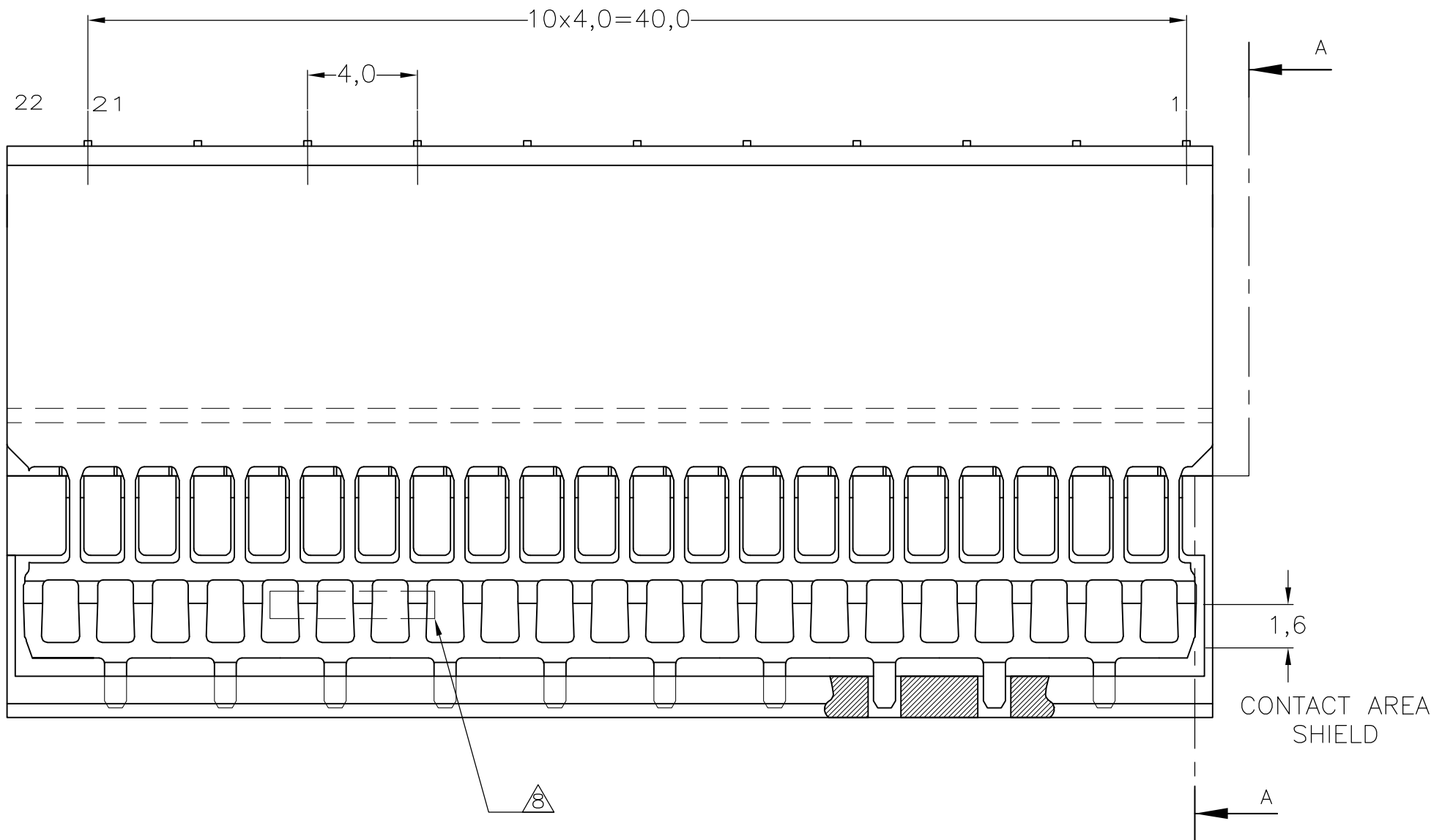
ROW "f" 11 PLATED THROUGH HOLES FOR UPSHIELD
- 13

SHIELD MOUNTED ON CONNECTOR WITH DOUBLE SIDED ADHESIVE TAPE OR ADHESIVE
- 14

BASIC P.N. LOWERSHIELD: 352468
- 15

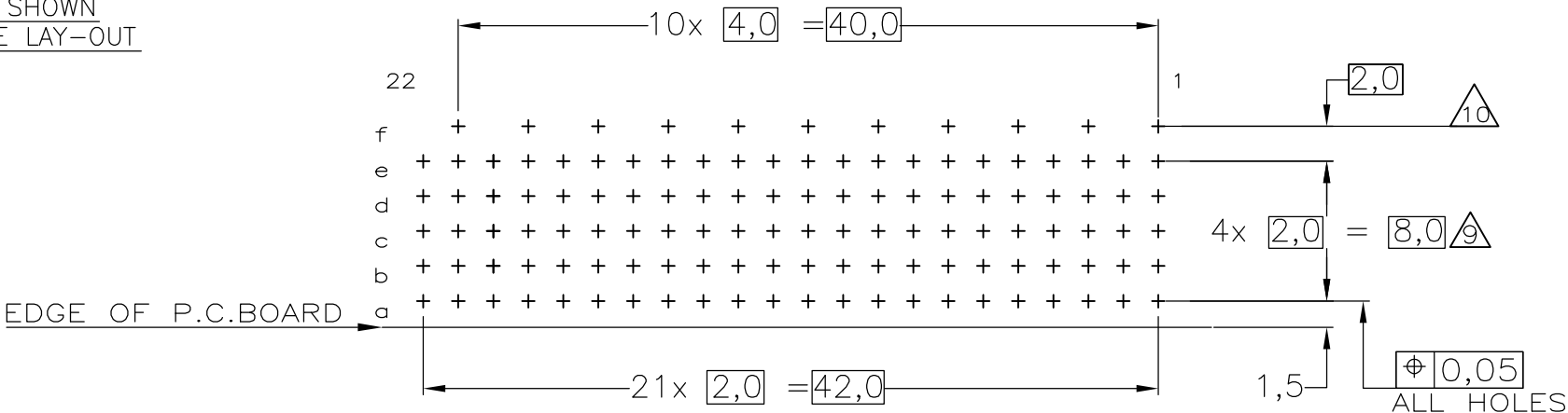
OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI
- 16

0.76um MIN GOLD PLATING ON MATING SURFACES



SCALE 2,5:1
COMPONENT SIDE AS SHOWN
RECOMMENDED PCB-HOLE LAY-OUT

P.C.B. HOLE DIM. ACTION PIN
FOR DETAILS SEE
APPLICATION SPECIFICATION



THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	D. TRUREN	23SEP96
DIMENSIONS:		CHK	-	-
mm		APVD	-	-
TOLERANCES UNLESS OTHERWISE SPECIFIED:		PRODUCT SPEC	108-19082	APPLICATION SPEC
0 PLG ±		WEIGHT	114-19029	-
1 PLG ±		RESTRICTED CUSTOMER	SCALE	NTS
2 PLG ±		SIZE	A2	00779
3 PLG ±		CAGE CODE	00779	DRAWING NO
4 PLG ±		RESTRICTED TO	-	-
ANGLES ±		SCALE	NTS	SHEET
FINISH		SCALE	NTS	1 OF 1

234	1	3-352152-0
236	1	352152-9
24	1	352152-4
23	1	352152-1
FINISH	MATERIAL	PARTNUMBER

TE Connectivity

Z-PACK 2MM HM
TYPE B - 22 COLUMNS
PRE-SHIELDED RECEPTACLE